

AT3216 Series

Multilayer Chip Antenna

Features

- ❖ Monolithic SMD with small, low-profile and light-weight type.
- ❖ Wide bandwidth

Applications

- ❖ Bluetooth/Wireless LAN/Home RF
- ❖ ISM band 2.4GHz applications



Specifications

Part Number	Frequency Range (MHz)	Peak Gain (XZ-V)	Average Gain (XZ-V)	VSWR	Impedance
AT3216 -B2R7HAA_	2400 ~ 2500	0.5 dBi typ.	-0.5 dBi typ.	2 max.	50 Ω

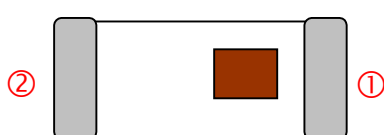
Q'ty/Reel (pcs) : 3,000pcs
 Operating Temperature Range : -40 ~ +85 °C
 Storage Temperature Range : -40 ~ +85 °C
 Power Capacity : 3W max.

Part Number

AT 3216 - B 2R7 HAA □
 ① ② ③ ④ ⑤ ⑥ ⑦

① Type	AT : Antenna	② Dimensions (L × W)	3.2× 1.6 mm
③ Material Code	B	④ Frequency Range	2R7=2700MHz
⑤ Specification Code	HAA	⑥ Packaging	T: Tape & Reel B: Bulk
⑦ Soldering	=lead-containing /LF=lead-free		

Terminal Configuration

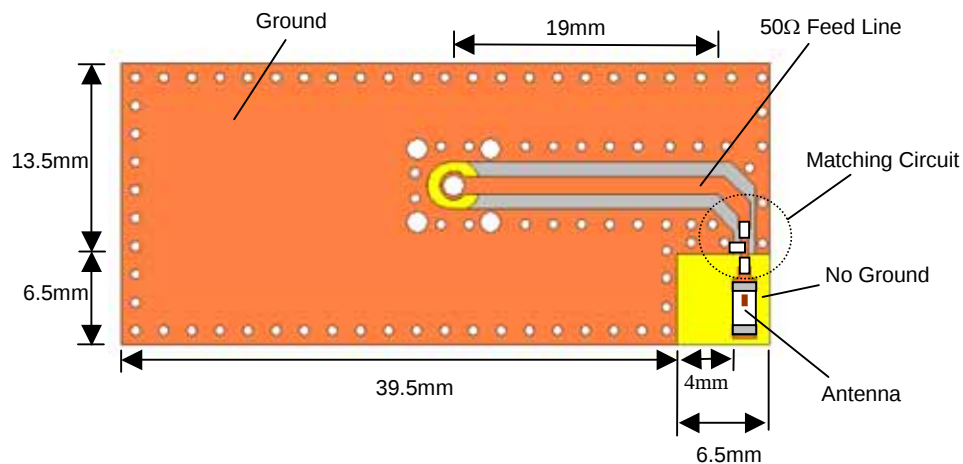


No.	Terminal Name	No.	Terminal Name
①	Feeding Point	②	NC

Unit : mm

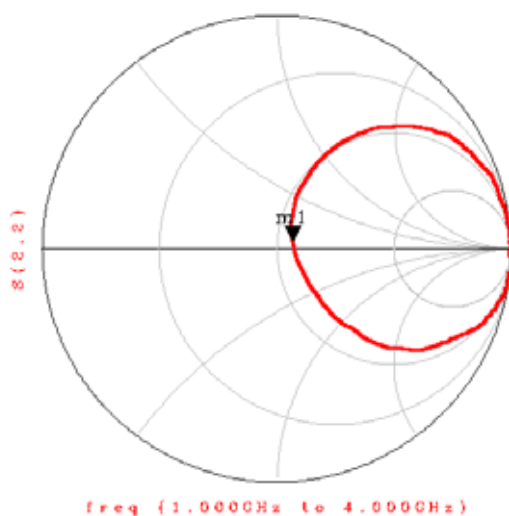
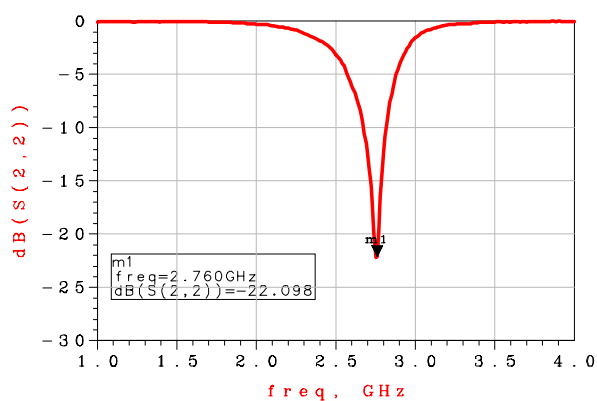
Typical Electrical Characteristics (T=25°C)

❖ Test Board

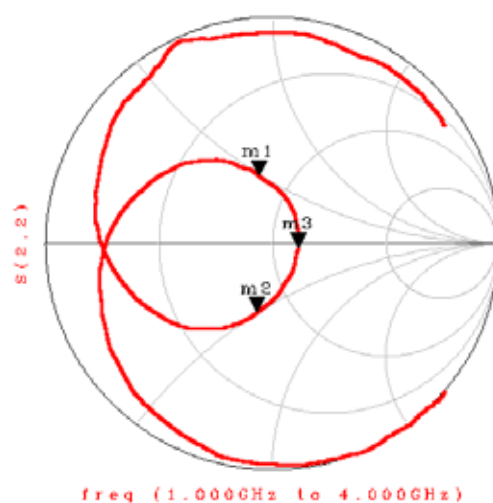
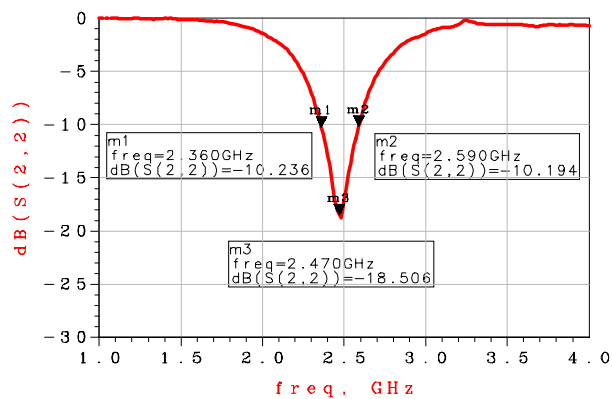


❖ Return Loss

(a) Without Matching Circuits

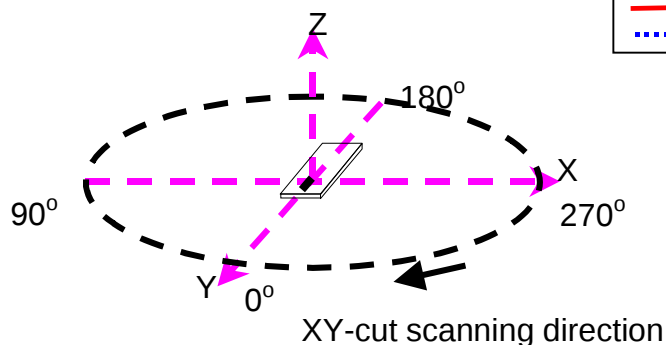


(b) With Matching Circuits

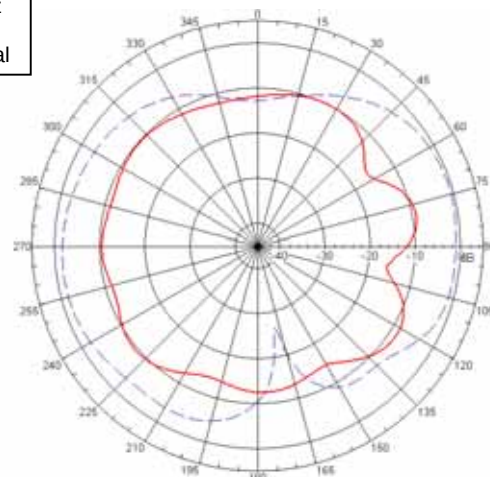


Radiation Patterns

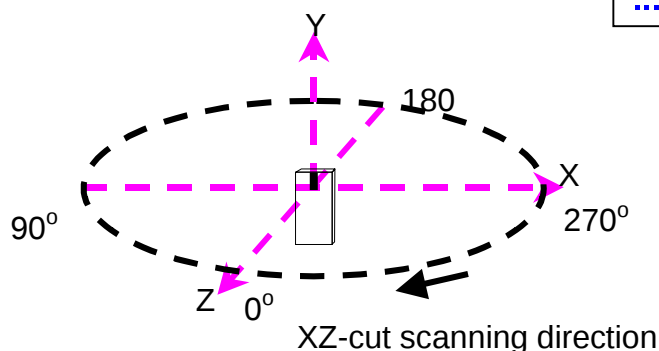
XY-V/XY-H



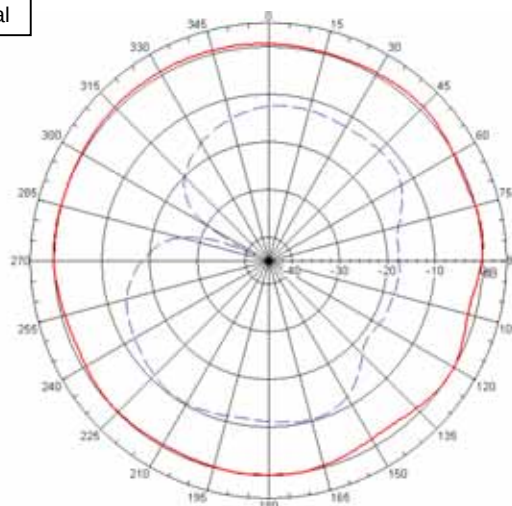
XY cut @2.45GHz
— Vertical
..... Horizontal



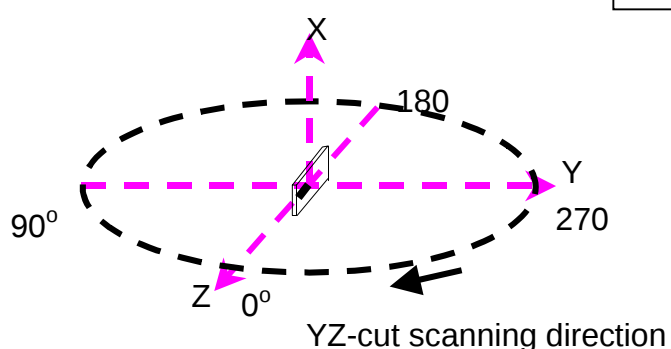
XZ-V/XZ-H



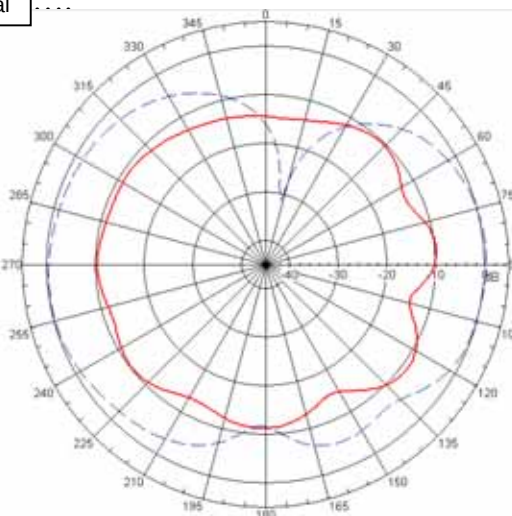
XZ cut @2.45GHz
— Vertical
..... Horizontal



YZ-V/YZ-H



YZ cut @2.45GHz
— Vertical
..... Horizontal



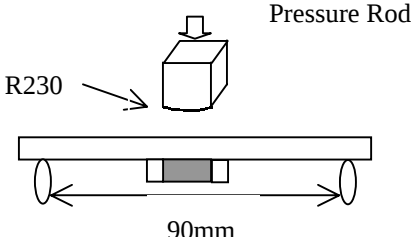
Advanced Ceramic X Corp.

16 Tzu Chiang Road, Hsinchu Industrial District Hsinchu Hsien 303, Taiwan

TEL:886-3-5987008 FAX:886-3-5987001

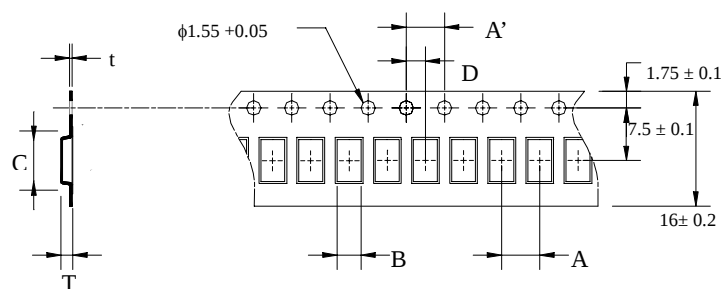
E-mail: acx@acxc.com.tw <http://www.acxc.com.tw>

Mechanical & Environmental Characteristics

	Requirements	Procedure
Solderability	1. No apparent damage 2. More than 75% of the terminal electrode shall be covered with new solder	1. Preheat: $120 \pm 5^{\circ}\text{C}$ 2. Solder: $230 \pm 5^{\circ}\text{C}$ for 5 ± 1 sec
Thermal shock (Temperature Cycle)	1. No apparent damage 2. Fulfill the electrical specification after test	1. One cycle/ step 1: $85 \pm 5^{\circ}\text{C}$ for 20sec step 2: $-40 \pm 3^{\circ}\text{C}$ for 20sec 2. Cycle time: 30min 3. No. of cycles: 100 4. Recovery: 1-2hrs
Heat Resistance	1. No apparent damage 2. Fulfill the electrical specification after test	1. Temperature: $85 \pm 2^{\circ}\text{C}$ 2. Duration: 24 ± 2hrs 3. Recovery: 1-2hrs
Low Temperature Resistance	1. No apparent damage 2. Fulfill the electrical specification after test	1. Temperature: $-40^{\circ} \pm 5^{\circ}\text{C}$ 2. Duration: 24 ± 2hrs 3. Recovery: 1-2hrs
Humidity Resistance	1. No apparent damage 2. Fulfill the electrical specification after test	1. Temperature: $85 \pm 2^{\circ}\text{C}$ 2. Humidity: 80% ~ 85% RH 3. Duration: 1000 ± 48hrs 4. Recovery: 1-2hrs
Soldering strength (Push strength)	1. 9.8N minimum	1. Solder specimen onto test jig. 2. Apply push force at 0.5mm/s until electrode pads are peeled off or ceramic are broken. Pushing force is applied to longitude direction
Deflection (Bending)	1. No apparent damage 2. Fulfill the electrical specification	1. Solder specimen onto test jig (FR4, 0.8mm) using the recommend soldering profile. 2. Apply a bending force of 2mm deflection 
Drop Shock	1. No apparent damage	1. Dropped onto hard wood from height of 50 cm for 3 times ; each x,y and z direction except terminal direction

Taping Specifications

❖ Tape Dimensions (Unit: mm)

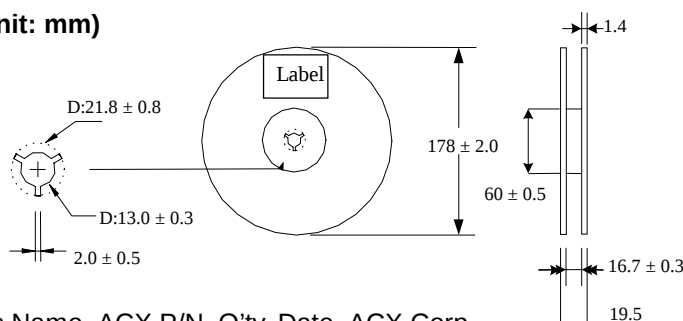


Type	A	A'	B	C	D	t	T
3216	4.0±0.1	4.0±0.1	1.9±0.1	3.5±0.1	2.0±0.1	0.20±0.05	Max. 1.4
5020	4.0±0.1	4.0±0.1	2.4±0.1	5.5±0.1	2.0±0.1	0.20±0.05	Max. 1.4
7020	4.0±0.1	4.0±0.1	2.4±0.1	7.3±0.1	2.0±0.1	0.22±0.05	Max. 1.55
7635	8.0±0.1	4.0±0.1	3.75±0.1	7.85±0.1	2.0±0.1	0.30±0.05	Max. 1.40
8516	4.0±0.1	4.0±0.1	1.85±0.1	8.70±0.1	2.0±0.1	0.25±0.05	Max. 1.40
9520	4.0±0.1	4.0±0.1	2.3±0.1	9.7±0.1	2.0±0.1	0.22±0.05	Max. 1.45
R130	8.0±0.1	4.0±0.1	3.35±0.1	10.35±0.1	2.0±0.1	0.25±0.05	Max. 1.40

❖ Quantity

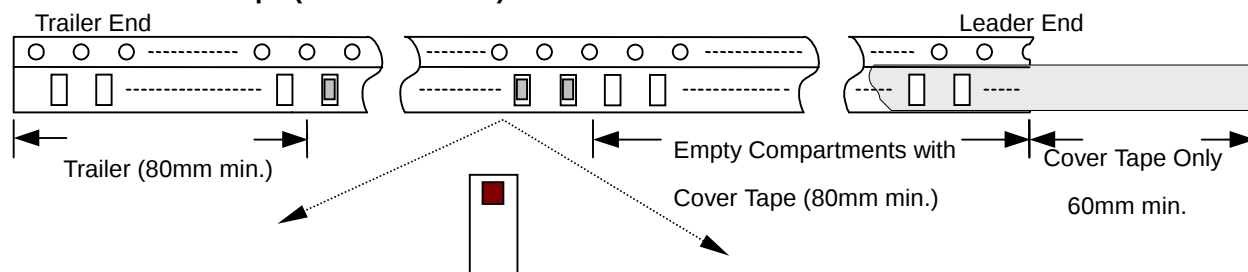
Type	3216	5020	7020	7635	8516	9520	R130
Quantity /per reel	3,000pcs	2,000	1,000 pcs	1,000 pcs	1000pcs	1,000 pcs	1,000 pcs

❖ Reel Dimensions (Unit: mm)

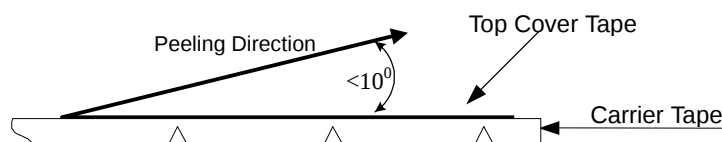


Label: Customer's Name, ACX P/N, Q'ty, Date, ACX Corp.

❖ Leader and Trailer Tape (Plastic material)



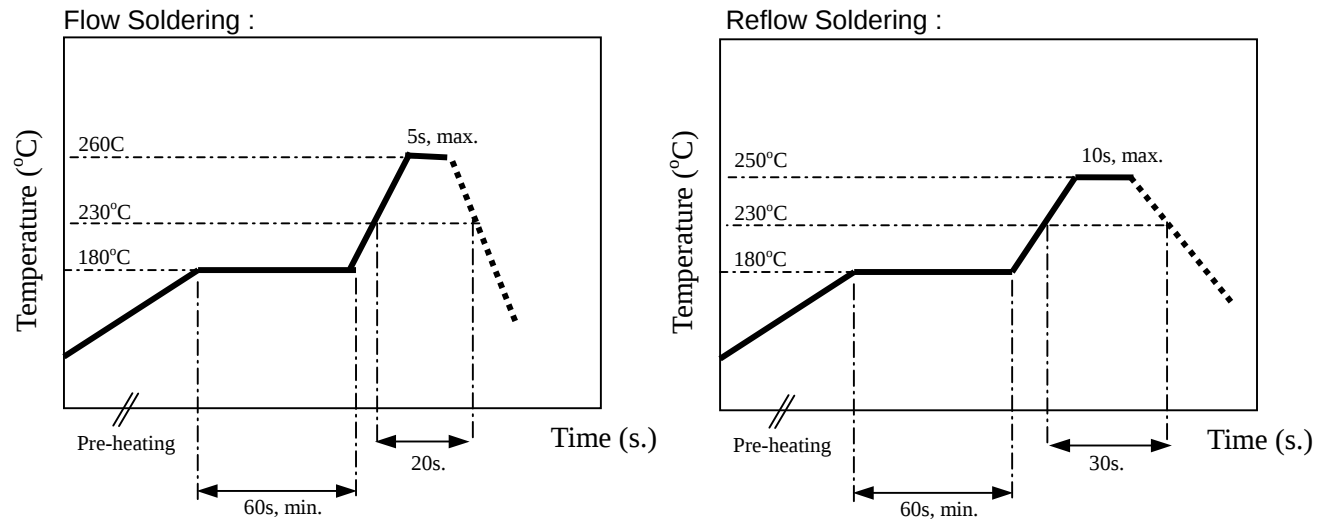
❖ Peel-off Force



Peel-off force should be in the range of 0.1 – 0.6 N at a peel-off speed of 300±10 mm/min .

Typical Soldering Profile

❖ Typical Soldering Profile for Lead-free Process



The sample must be pre-heated before soldering .The temperature difference between preheating and soldering must be within 150 .

Notes

❖The contents of this data sheet are subject to change without notice. Please confirm the specifications and delivery conditions when placing your order.

❖Storage Conditions

- (1) Temperature: 15 ~35 , relative humidity (RH): 45~75%.
- (2) Non-corrosive environment
- (3) Products should be used within six months of receipt.

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